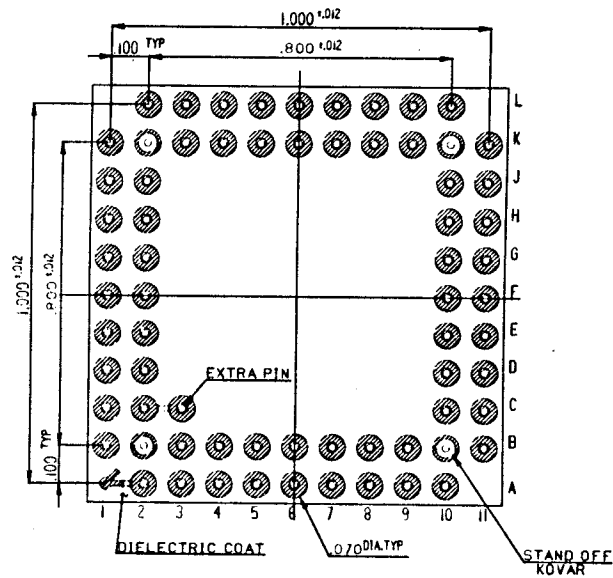
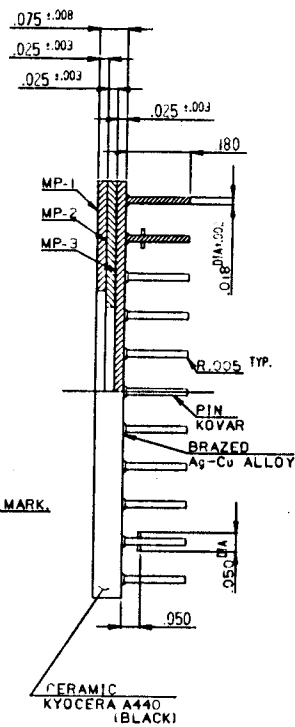


THIS METALLIZED SURFACE TO BE FLAT WITHIN .002 TIR.
 THIS METALLIZED SURFACE TO BE FLAT WITHIN .003 TIR.

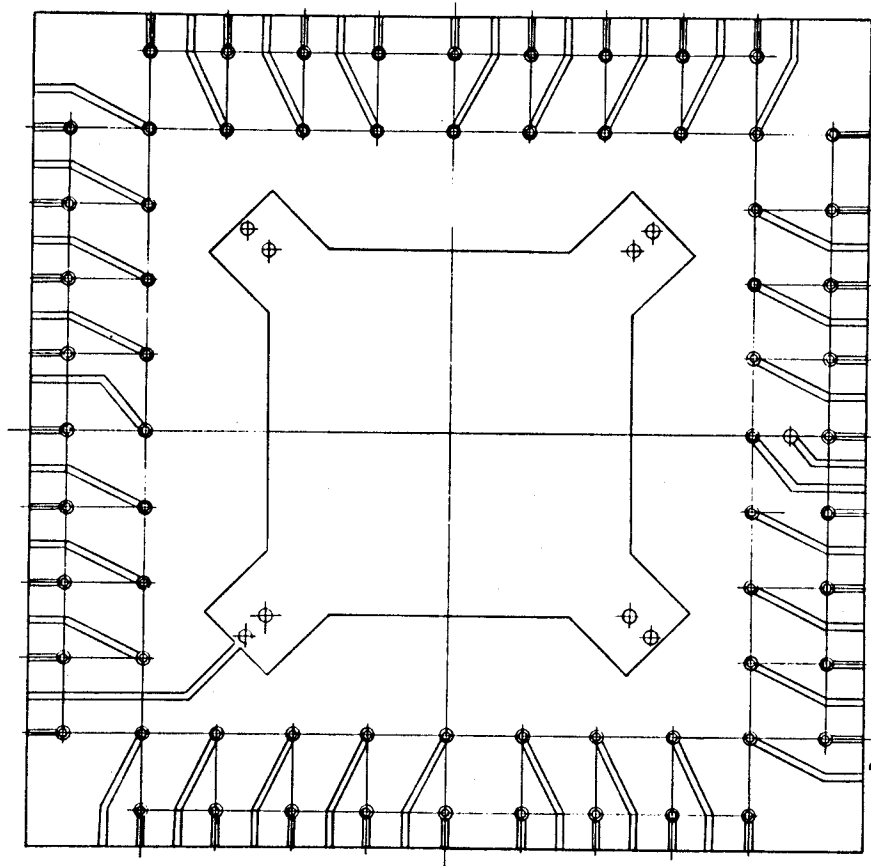
SNAPPING OFF AFTER Au PLATING (APCS)



- NOTES,
 1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
 2. LEAD RESISTANCE: PIN NO. 1, 9, 18, 26, 35, 43, 52, 60 ----- 0.2Ω MAX.
 THE OTHERS ----- 1.0Ω MAX.
 3. BEAL AREA TO BE METALLIZED
 4. DIE ATTACH AREA TO BE METALLIZED
 5. BEAL RING AND DIE ATTACH PAD TO BE FLOATING FROM ANY PINS.

P8068R018-1

REVISIONS	NAME	68 PIN GRID ARRAY PACKAGE	TOLERANCES	DRAWN	CHECKED
	SCALE	MATERIAL	UNLESS OTHERWISE SPECIFIED	<i>W. H. H.</i>	<i>K. H. H.</i>
	5:1	AS INDICATED	±10% RLT ±.008	APPROVED	DATE
	CHANGE	DATE	DRAWN	CHECKED	APPROVED
DATE		DATE	DATE	DATE	DATE
KYOCERA CORPORATION			KYOTO JAPAN	DWG NO.	KD-85018



MP-2

MODIFICATIONS _____ _____ _____	NAME 68 PIN GRID ARRAY PACKAGE	TOLERANCES (DIMENSIONS UNLESS OTHERWISE SPECIFIED)	DRAWN <i>[Signature]</i>	CHECKED <i>[Signature]</i>
	SCALE 10:1	MATERIAL	APPROVED <i>[Signature]</i>	DATE JAN 19 85
CHANGE	DATE	DRAWN	CHECKED	APPROVED
KYOCERA CORPORATION KYOTO JAPAN			DWG. NO. KD-85018 3/4	

